SiHF22N60E

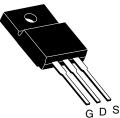


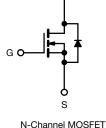


E Series Power MOSFET

PRODUCT SUMMA	RY	
V _{DS} (V) at T _J max.	650)
R _{DS(on)} max. (Ω) at 25 °C	$V_{GS} = 10 V$	0.18
Q _g max. (nC)	86	
Q _{gs} (nC)	11	
Q _{gd} (nC)	24	
Configuration	Sing	le

TO-220 FULLPAK





FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- · Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-220 FULLPAK
Lead (Pb)-free	SiHF22N60E-E3
Lead (Pb)-free and Halogen-free	SiHF22N60E-GE3

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, unl	ess otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			V _{DS}	600	V
Gate-Source Voltage			V _{GS}	± 30	v
Continuous Drain Current (T, = 150 °C) ^e	V at 10 V	T _C = 25 °C T _C = 100 °C	- I _D	21	
Continuous Drain Current $(T_j = 150 \text{ C})^2$	V _{GS} at 10 V	T _C = 100 °C		13	А
Pulsed Drain Current ^a			I _{DM}	56	
Linear Derating Factor				0.28	W/°C
Single Pulse Avalanche Energy ^b			E _{AS}	367	mJ
Maximum Power Dissipation			PD	35	W
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +150	°C
Drain-Source Voltage Slope	$T_J = 1$	125 °C	d\//dt	70	V/ns
Reverse Diode dV/dt ^d		dV/dt	11	V/ns	
Soldering Recommendations (Peak temperature) ^c	for	10 s		300	°C
Mounting Torque	M3 s	screw		0.6	Nm

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 5.1 A.

c. 1.6 mm from case.

d. $I_{SD} \leq I_D$, dl/dt = 100 A/µs, starting T_J = 25 °C.

e. Limited by maximum junction temperature.

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PARAMETER	SYMBOL	TYP.		MAX.			UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-		65			°C (M)	
Maximum Junction-to-Case (Drain)	R _{thJC}	- 3.6			°C/W			
			•					
SPECIFICATIONS (T _J = 25 °C, u	nless otherw	ise noted)						
PARAMETER	SYMBOL			ONS	MIN.	TYP.	MAX.	UNI
Static								
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} :	= 0 V, I _D = 2	250 μA	600	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$		to 25 °C, I		-	0.71	-	V/°(
Gate-Source Threshold Voltage (N)	V _{GS(th)}		= V _{GS} , I _D = 2		2	-	4	V
	00(0)		$V_{GS} = \pm 20$		-	-	± 100	nA
Gate-Source Leakage	I _{GSS}		$V_{GS} = \pm 30$		-	-	± 1	μA
Zero Gate Voltage Drain Current			= 600 V, V _{GS}		-	-	1	
	I _{DSS}	-		$V_{\rm GS} = 0 \text{ V}, \text{ T}_{\rm J} = 125 \text{ °C}$		-	10	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V		₀ = 11 A	-	0.15	0.18	Ω
Forward Transconductance	9 _{fs}	V _D	_S = 8 V, I _D =	5 A	-	6.4	-	S
Dynamic		•	-		<u>.</u>	<u>.</u>		•
Input Capacitance	C _{iss}		V _{GS} = 0 V,		-	1920	-	
Output Capacitance	C _{oss}		$V_{DS} = 100$ \	Ι,	-	90	-	
Reverse Transfer Capacitance	C _{rss}		f = 1 MHz		-	6	-	
Effective Output Capacitance, Energy Related ^a	C _{o(er)}		()		-	73	-	pF
Effective Output Capacitance, Time Related ^b	C _{o(tr)}	$ V_{DS} = 0$ V	/ to 480 V, \	V _{GS} = 0 V	-	263	-	
Total Gate Charge	Qg				-	57	86	
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 V$	I _D = 11 A	A, V _{DS} = 480 V	-	11	-	nC
Gate-Drain Charge	Q _{gd}				-	24	-	
Turn-On Delay Time	t _{d(on)}				-	18	36	
Rise Time	t _r	V _{PP} -	- 380 V In -	- 11 Δ	-	27	54	
Turn-Off Delay Time	t _{d(off)}	V_{DD} = 380 V, I _D = 11 A, V _{GS} = 10 V, R _g = 4.7 Ω		-	66	99	ns	
Fall Time	t _f		-		-	35	70	
Gate Input Resistance	Rg	f = 1 MHz, open drain		0.3	0.77	1.2	Ω	
Drain-Source Body Diode Characteristic	cs							
Continuous Source-Drain Diode Current	I _S	MOSFET sym showing the			-	-	21	
Pulsed Diode Forward Current	I _{SM}	integral revers p - n junction			-	-	56	Δ
Diode Forward Voltage	V _{SD}	T _J = 25 °0	C, I _S = 11 A	, V _{GS} = 0 V	-	-	1.2	V
Reverse Recovery Time	t _{rr}				-	344	-	n
Reverse Recovery Charge	Q _{rr}	$T_J = 2$	5 °C, I _F = I _S 100 A/us M	= 11 A,	-	5.3	-	μ
Reverse Recovery Current	I _{RRM}	dl/dt = 100 A/µs, V _R = 25 V		-	28	-	A	

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

b. C_{oss(tr)} is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}.



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

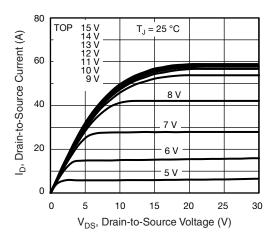


Fig. 1 - Typical Output Characteristics

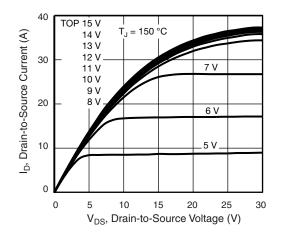


Fig. 2 - Typical Output Characteristics

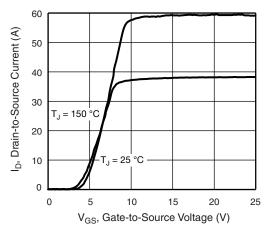


Fig. 3 - Typical Transfer Characteristics

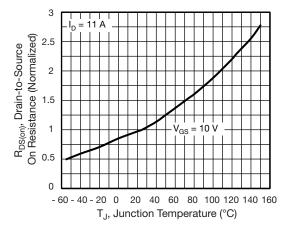


Fig. 4 - Normalized On-Resistance vs. Temperature

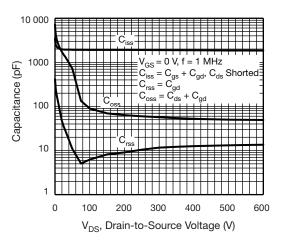


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

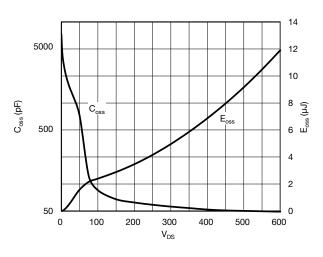


Fig. 6 - $C_{\rm oss}$ and $E_{\rm oss}$ vs. $V_{\rm DS}$

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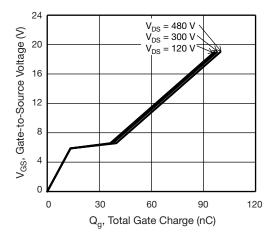


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

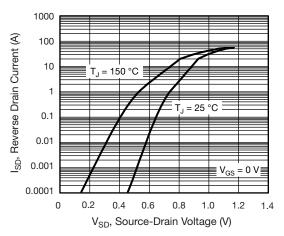


Fig. 8 - Typical Source-Drain Diode Forward Voltage

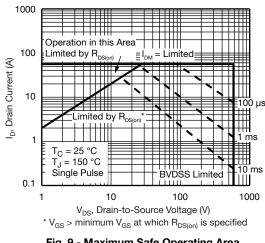


Fig. 9 - Maximum Safe Operating Area

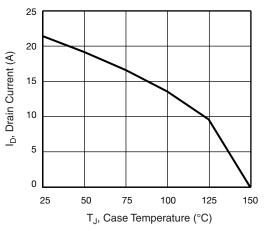


Fig. 10 - Maximum Drain Current vs. Case Temperature

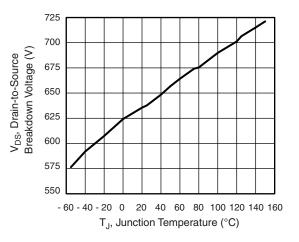


Fig. 11 - Temperature vs. Drain-to-Source Voltage

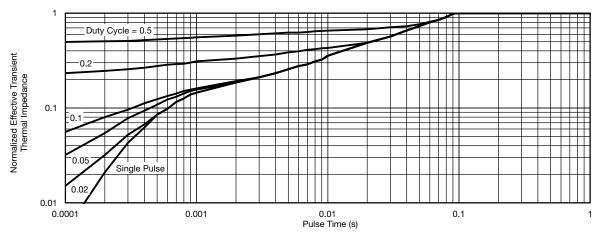
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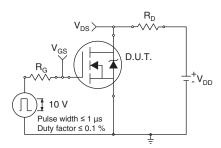


Fig. 13 - Switching Time Test Circuit

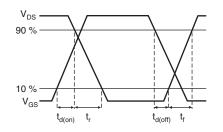


Fig. 14 - Switching Time Waveforms

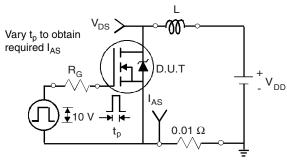


Fig. 15 - Unclamped Inductive Test Circuit

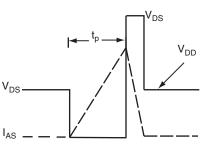


Fig. 16 - Unclamped Inductive Waveforms

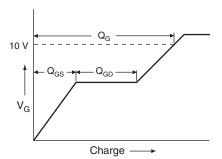


Fig. 17 - Basic Gate Charge Waveform

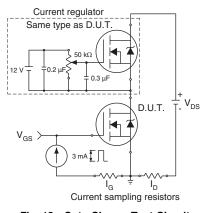


Fig. 18 - Gate Charge Test Circuit

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Peak Diode Recovery dV/dt Test Circuit

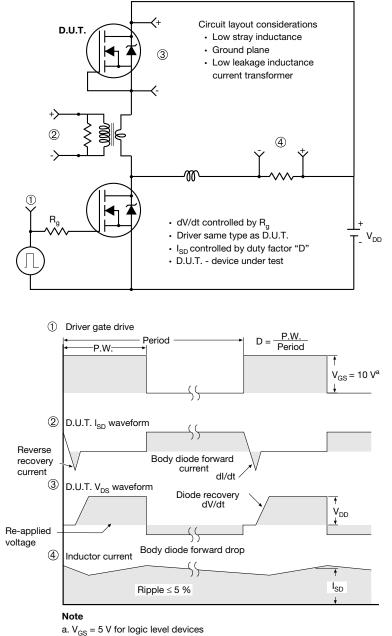


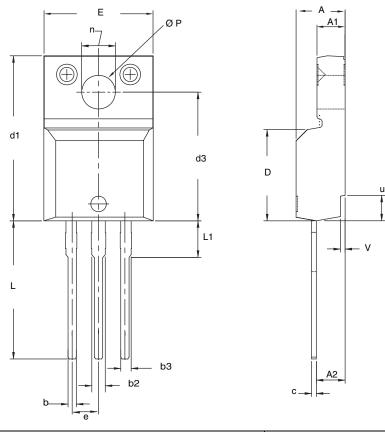
Fig. 19 - For N-Channel

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Package Information

Vishay Siliconix

TO-220 FULLPAK (HIGH VOLTAGE)



DIM.	MILLIN	METERS	INCHES		
	MIN.	MAX.	MIN.	MAX.	
А	4.570	4.830	0.180	0.190	
A1	2.570	2.830	0.101	0.111	
A2	2.510	2.850	0.099	0.112	
b	0.622	0.890	0.024	0.035	
b2	1.229	1.400	0.048	0.055	
b3	1.229	1.400	0.048	0.055	
С	0.440	0.629	0.017	0.025	
D	8.650	9.800	0.341	0.386	
d1	15.88	16.120	0.622	0.635	
d3	12.300	12.920	0.484	0.509	
E	10.360	10.630	0.408	0.419	
е	2.54	BSC	0.100 BSC		
L	13.200	13.730	0.520	0.541	
L1	3.100	3.500	0.122	0.138	
n	6.050	6.150	0.238	0.242	
ØР	3.050	3.450	0.120	0.136	
u	2.400	2.500	0.094	0.098	
V	0.400	0.500	0.016	0.020	

Notes

1. To be used only for process drawing. 2. These dimensions apply to all TO-220, FULLPAK leadframe versions 3 leads. 3. All critical dimensions should C meet $C_{pk} > 1.33$.

4. All dimensions include burrs and plating thickness.

5. No chipping or package damage.



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